ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	C. Bannock	burn, Illinois, A	Il rights reserved nations.	under both	This docum level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufactu level materials for w	rer listed	item. Note: nanufactur	if the item is an as rer has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC 1752 Standard Form Ty				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					s and Mfg Information			
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
nsemi						, I				2024-05	2024-05-04			
ntact Name Title - Contact			et	P			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - R			e - Representative			Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NVMFI T1G	VMFD5C674NLWF T6 60V LL S0 G		FLDS		2024-05-04		N	MY1		89.49	mg	Each	
Manufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	erial Terminal Base All		Alloy	J-STD-020 MSL Ratin		Peak Proc	Process Body Temperat		ure Max Time at Peak Tem		ture Nun	nber of Reflow Cyd	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	1			<b>260</b> C		С	30 seco		seconds 3			
Comments														
level 1 - maximum time at peak temperatu	re during so	oldering is 10-3	0 seconds											
For more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	0.34	mg	Supplier	Zinc (Zn)	7440-66-6		0.0004	mg
			Supplier	Iron (Fe)	7439-89-6		0.008	mg
			Supplier	Copper (Cu)	7440-50-8		0.3315	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0001	mg
Die	0.36	mg	Supplier	Silicon (Si)	7440-21-3		0.36	mg
Die Attach Solder	0.82	mg	Supplier	Silver (Ag)	7440-22-4		0.0205	mg
			А	Lead (Pb)	7439-92-1	7a	0.7585	mg
			Supplier	Tin (Sn)	7440-31-5		0.041	mg
Lead Frame	37.39	mg	Supplier	Silver (Ag)	7440-22-4		0.3739	mg
			Supplier	Iron (Fe)	7439-89-6		0.0374	mg
			Supplier	Copper (Cu)	7440-50-8		36.9675	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0112	mg
Mold Compound-Black	48.93	mg		Epoxy resin	proprietary data		3.6698	mg
			Supplier	Phenolic Resin	Proprietary Data		1.2233	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.6698	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2446	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.1226	mg
Plating	1.56	mg	Supplier	Tin (Sn)	7440-31-5		1.56	mg
Wire Bond - Cu	0.09	mg	Supplier	Copper (Cu)	7440-50-8		0.09	mg